

S1AF THRU S1MF

SURFACE MOUNT GENERAL PURPOSE SILICON RECTIFIER

Reverse Voltage – 50 to 1000 V

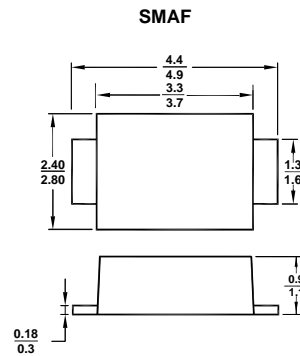
Forward Current – 1 A

Features

- Glass Passivated Chip Junction
- For surface mount applications
- Low profile package
- Easy pick and place

Mechanical Data

- **Case:** SMAF
- **Terminals:** Solderable per MIL-STD-750, method 2026



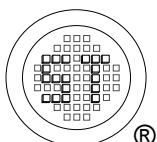
All Dimensions in mm

Maximum Ratings and Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified. Single phase half-wave 60 Hz, resistive or inductive load, for capacitive load current derate by 20%.

Parameter	Symbols	S1AF	S1BF	S1DF	S1GF	S1JF	S1KF	S1MF	Units
Marking		S1A	S1B	S1D	S1G	S1J	S1K	S1M	-
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	V_{RMS}	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	V_{DC}	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current at $T_a = 65^\circ\text{C}$	$I_{F(AV)}$	1							A
Peak Forward Surge Current 8.3 ms Single Half Sine-wave Superimposed on Rated Load (JEDEC Method)	I_{FSM}	30							A
Maximum Forward Voltage at 1 A	V_F	1.1							V
Maximum DC Reverse Current at Rated DC Blocking Voltage	I_R	5 50							μA
Typical Junction Capacitance at $V_R = 4\text{ V}$, $f = 1\text{ MHz}$	C_J	4							pF
Typical Thermal Resistance ¹⁾	$R_{\theta JA}$	180							$^\circ\text{C/W}$
Operating and Storage Temperature Range	T_j, T_{stg}	- 55 to + 150							$^\circ\text{C}$

¹⁾ P.C.B. mounted with 0.2 X 0.2" (5 X 5 mm) copper pad areas.

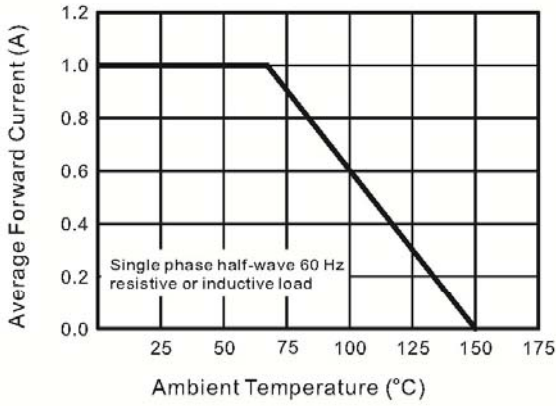


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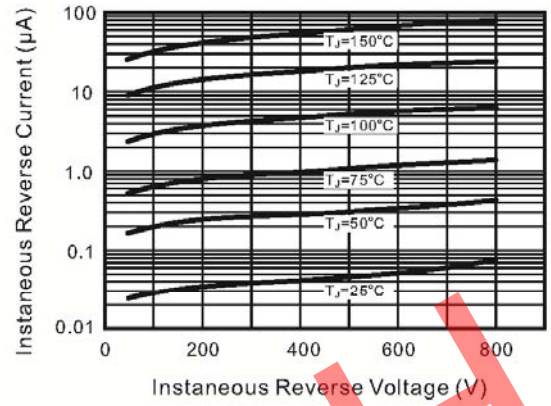


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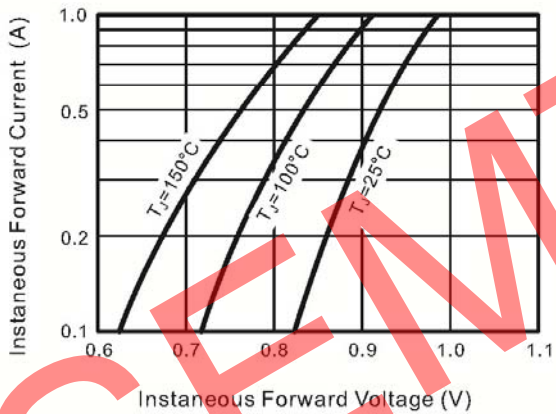
Forward Current Derating Curve



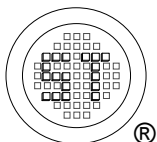
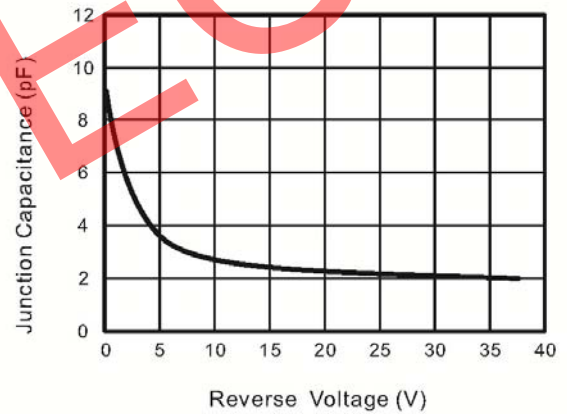
Typical Instantaneous Reverse Characteristics



Typical Forward Characteristic



Typical Junction Capacitance



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